Hex buffer/line driver; 3-state; inverting Rev. 3 — 13 March 2024

**Product data sheet** 

### 1. General description

The 74HC366-Q100; 74HCT366-Q100 is a hex inverting buffer/line driver with 3-state outputs controlled by the output enable inputs ( $\overline{OEn}$ ). A HIGH on  $\overline{OEn}$  causes the outputs to assume a high impedance OFF-state. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
   Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Inverting outputs
- Input levels:
  - For 74HC366-Q100: CMOS level
  - For 74HCT366-Q100: TTL level
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V

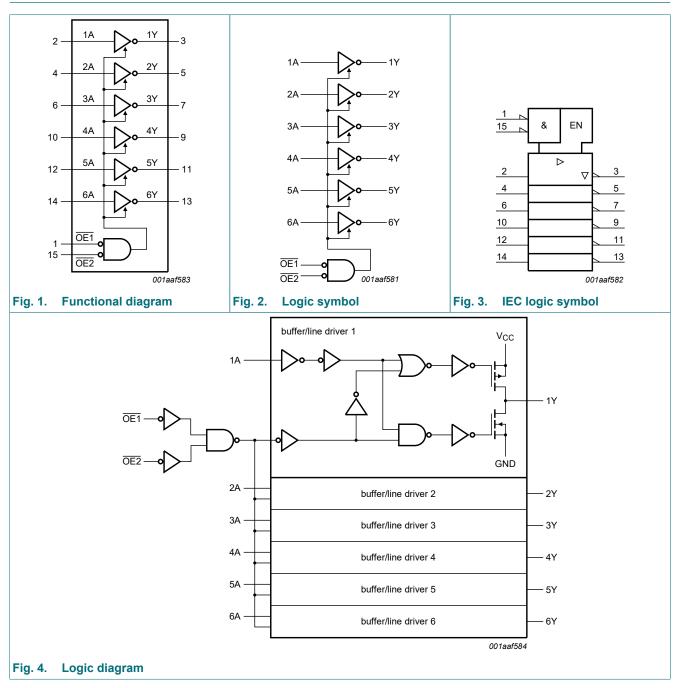
### 3. Ordering information

#### Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC366D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	<u>SOT109-1</u>
74HCT366D-Q100			body width 3.9 mm	
74HC366PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package;	<u>SOT403-1</u>
74HCT366PW-Q100			16 leads; body width 4.4 mm	

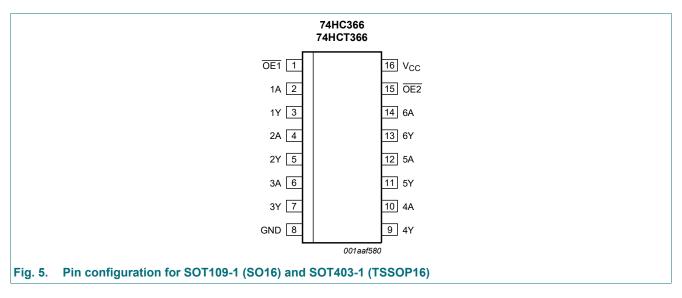
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# 4. Functional diagram



### 5. Pinning information





### 5.2. Pin description

#### Table 2. Pin description

Symbol	Pin	Description
OE1, OE2	1, 15	output enable input (active LOW)
1A, 2A, 3A, 4A, 5A, 6A	2, 4, 6, 10, 12, 14	data input
1Y, 2Y, 3Y, 4Y, 5Y, 6Y	3, 5, 7, 9, 11, 13	data output
GND	8	ground (0 V)
V <sub>CC</sub>	16	supply voltage

### 6. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Control		Input	Output
OE1	OE2	nA	nY
L	L	L	Н
L	L	Н	L
Х	Н	Х	Z
Н	Х	X	Z

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 V \text{ or } V_{I} > V_{CC} + 0.5 V$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
lo	output current	$V_{O} = -0.5 \text{ V to} (V_{CC} + 0.5 \text{ V})$	-	±35	mA
I <sub>CC</sub>	supply current		-	70	mA
I <sub>GND</sub>	ground current		-	-70	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[1]	-	500	mW

For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C.
 For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C.

### 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74	74HC366-Q100			74HCT366-Q100		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

# 9. Static characteristics

#### Table 6. Static characteristics 74HC366-Q100

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C		<b>I</b>			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	V
		V <sub>CC</sub> = 4.5 V	3.15	2.4	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	V
		V <sub>CC</sub> = 4.5 V	-	2.1	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	-	-	-	
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	V
		I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	V
		I <sub>O</sub> = -7.8 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	V
		I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	V
l <sub>l</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or GND}; V_{CC} = 6.0 \text{ V}$	-	-	±0.5	μA
I <sub>CC</sub>	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 6.0$ V	-	-	8.0	μA
CI	input capacitance		-	3.5	-	pF

### Hex buffer/line driver; 3-state; inverting

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	40 °C to +85 °C					
VIH	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	-	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	3.15       -       -         4.2       -       -         -       -       0.5         -       -       1.35         -       -       1.35         -       -       1.35         -       -       1.35         -       -       1.35         -       -       1.35         -       -       1.8         1.9       -       -         1.9       -       -         4.4       -       -         5.9       -       -         3.84       -       -         5.34       -       -         -       0.1       -         -       0.1       -         -       0.1       -         -       0.33       -         -       -       0.33         -       -       1.0         /       -       -         3.15       -       -         1.5       -       -         3.15       -       -         -       1.35       -         -       1.35       -      <	V		
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	-	-	V
		I <sub>O</sub> = -6.0 mA; V <sub>CC</sub> = 4.5 V	3.84	-	-	V
		I <sub>O</sub> = -7.8 mA; V <sub>CC</sub> = 6.0 V	5.34	-	-	V
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	-	0.1	V
		I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V	-	-	0.33	V
		I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V	-	-	0.33	V
lı –	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V;	-	-	±1.0	μA
l <sub>oz</sub>	OFF-state output current	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{O} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±5.0	μA
Icc	supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V	-	-	80	μA
$T_{amb} = -4$	40 °C to +125 °C					
VIH	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5 \	V		
		V <sub>CC</sub> = 4.5 V	3.15	-		V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
VIL	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	-           -           0.5           1.35           1.35           1.3           -           -           -           -           -           -           -           -           -           -           -           0.1           0.1           0.1           0.33           ±1.0           ±5.0           80                    0.33           ±1.0           0.33           1.35      <	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	_	$\begin{array}{c ccc}  & 0.1 \\  & 0.33 \\  & 0.33 \\  & \pm 1.0 \\  & \pm 5.0 \\  & 80 \\  & & \\  &$	V
V <sub>OH</sub>	HIGH-level output voltage					
0.11		$I_{\rm O} = -20 \ \mu \text{A}; \ V_{\rm CC} = 2.0 \ \text{V}$	1.9	_	-	V
		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	-	-	V
		$I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 6.0 \ \text{V}$	5.9	-	-	V
		$I_{\rm O}$ = -6.0 mA; V <sub>CC</sub> = 4.5 V	3.7	-	-	V
		$I_{\rm O}$ = -7.8 mA; $V_{\rm CC}$ = 6.0 V	5.2	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
02		$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_{\rm O} = 20 \ \mu \text{A}; \ V_{\rm CC} = 6.0 \ \text{V}$	-	-		V
		$I_0 = 6.0 \text{ mA; } V_{CC} = 4.5 \text{ V}$	-	_		V
		$I_0 = 7.8 \text{ mA; } V_{CC} = 6.0 \text{ V}$	-	_		V
I <sub>I</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	_	-		μA
l <sub>oz</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{O} = V_{CC} \text{ or GND}; V_{CC} = 6.0 \text{ V}$	_	-	±10.0	
I <sub>CC</sub>	supply current	$V_{\rm I} = V_{\rm CC}$ or GND; $I_{\rm O} = 0$ A; $V_{\rm CC} = 6.0$ V		_		μA

74HC\_HCT366\_Q100

#### Table 7. Static characteristics 74HCT366-Q100

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C	·				
VIH	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	V
V <sub>OH</sub>	HIGH-level output	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
	voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	V
		I <sub>O</sub> = -6.0 mA	3.98	4.32	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I <sub>O</sub> = 20 μA	-	0	0.1	V
		I <sub>O</sub> = 6.0 mA	-	0.16	0.26	V
I <sub>I</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	μA
l <sub>oz</sub>	OFF-state output current	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{O} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.5	μA
I <sub>CC</sub>	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 \text{ V}$ ; other inputs at $V_{CC}$ or GND; $I_O = 0 \text{ A}$				
		pins nA	-	100	360	μA
		pin OE1	-	100	360	μA
		pin OE2	-	90	320	μA
CI	input capacitance		-	3.5	-	pF
T <sub>amb</sub> = -4	40 °C to +85 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I <sub>O</sub> = -20 μA	4.4	-	-	V
		I <sub>O</sub> = -6.0 mA	3.84	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I <sub>O</sub> = 20 μA	-	-	0.1	V
		I <sub>O</sub> = 6.0 mA	-	-	0.33	V
I <sub>I</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{O} = V_{CC}$ or GND; $V_{CC} = 5.5 V$			±5.0	μA
I <sub>CC</sub>	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 5.5$ V	-	-	80	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 V$ ; other inputs at $V_{CC}$ or GND; $I_O = 0 A$				
		pins nA	-	-	450	μA
		pin OE1	-	-	450	μA
		pin OE2	-	-	400	μA

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +125 °C		-			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I <sub>O</sub> = -20 μA	4.4	-	-	V
		I <sub>O</sub> = -6.0 mA	3.7	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$				
		I <sub>O</sub> = 20 μA	-	-	0.1	V
		I <sub>O</sub> = 6.0 mA	-	-	0.4	V
I <sub>I</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μA
I <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH}$ or $V_{IL}$ ; $V_{O} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±10.0	μA
I <sub>CC</sub>	supply current	$V_{I} = V_{CC}$ or GND; $I_{O} = 0$ A; $V_{CC} = 5.5$ V	-	-	160	μA
ΔI <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 \text{ V}$ ; other inputs at $V_{CC}$ or GND; $I_O = 0 \text{ A}$				
		pins nA	-	-	490	μA
		pin OE1	-	-	490	μA
		pin OE2	-	-	441	μA

# **10.** Dynamic characteristics

#### Table 8. Dynamic characteristics 74HC366-Q100

Voltages are referenced to GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; see test circuit Fig. 8.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C		l			1	
t <sub>pd</sub>	propagation delay	nA to nY; see <u>Fig. 6</u>	[1]				
		V <sub>CC</sub> = 2.0 V		-	33	100       20       -       17       150       30       26       150       30       26       150       30       26       150       30       26       150       30       26       150       30       26       150       30       26       10	ns
		V <sub>CC</sub> = 4.5 V		-	12		ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	10	-	ns
		V <sub>CC</sub> = 6.0 V		-	10	17	ns
t <sub>en</sub>	enable time	OEn to nY; see Fig. 7	[2]				
		V <sub>CC</sub> = 2.0 V		-	44	150	ns
		V <sub>CC</sub> = 4.5 V		-	16	30	ns
		V <sub>CC</sub> = 6.0 V		-	13	26	ns
t <sub>dis</sub>	disable time	OEn to nY; see Fig. 7	[3]			3 20	
		V <sub>CC</sub> = 2.0 V		-	55	150	ns
		V <sub>CC</sub> = 4.5 V		-	20	30	ns
		V <sub>CC</sub> = 6.0 V		-	16	26	ns
t <sub>t</sub>	transition time	see <u>Fig. 6</u>	[4]				
		V <sub>CC</sub> = 2.0 V		-	14	60	ns
		V <sub>CC</sub> = 4.5 V		-	5	12	ns
		V <sub>CC</sub> = 6.0 V		-	4	10	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $V_I$ = GND to $V_{CC}$	[5]	-	30	-	pF

#### Hex buffer/line driver; 3-state; inverting

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
T <sub>amb</sub> = -4	40 °C to +85 °C						-
pd	propagation delay	nA to nY; see <u>Fig. 6</u>	[1]				
		V <sub>CC</sub> = 2.0 V		-	-	125	ns
		V <sub>CC</sub> = 4.5 V		-	-	25	ns
		V <sub>CC</sub> = 6.0 V		-	-	21	ns
en	enable time	OEn to nY; see Fig. 7	[2]				
		V <sub>CC</sub> = 2.0 V		-	-	190	ns
		V <sub>CC</sub> = 4.5 V		-	-	38	ns
		V <sub>CC</sub> = 6.0 V		-	-	33	ns
dis	disable time	OEn to nY; see <u>Fig. 7</u>	[3]				
		V <sub>CC</sub> = 2.0 V		-	-	190	ns
		V <sub>CC</sub> = 4.5 V		-	-	38	ns
		V <sub>CC</sub> = 6.0 V		-	-	33	ns
t	transition time	see <u>Fig. 6</u>	[4]				
		V <sub>CC</sub> = 2.0 V		-	-	75	ns
		V <sub>CC</sub> = 4.5 V		-	-	15	ns
		V <sub>CC</sub> = 6.0 V		-	-	13	ns
T <sub>amb</sub> = -4	40 °C to +125 °C						
pd	propagation delay	nA to nY; see <u>Fig. 6</u>	[1]				
		V <sub>CC</sub> = 2.0 V		-	-	150	ns
		$V_{CC} = 4.5 V$		-	-	30	ns
		V <sub>CC</sub> = 6.0 V		-	-	26	ns
en	enable time	OEn to nY; see <u>Fig. 7</u>	[2]				
		V <sub>CC</sub> = 2.0 V		-	-	225	ns
		$V_{CC}$ = 4.5 V		-	-	45	ns
		V <sub>CC</sub> = 6.0 V		-	-	38	ns
dis	disable time	OEn to nY; see <u>Fig. 7</u>	[3]				
		V <sub>CC</sub> = 2.0 V		-	-	225	ns
		V <sub>CC</sub> = 4.5 V		-	-	45	ns
		V <sub>CC</sub> = 6.0 V		-	-	38	ns
t	transition time	see <u>Fig. 6</u>	[4]				
		V <sub>CC</sub> = 2.0 V		-	-	90	ns
		V <sub>CC</sub> = 4.5 V		-	-	18	ns
		V <sub>CC</sub> = 6.0 V		-	-	15	ns

 $[1] \quad t_{pd} \text{ is the same as } t_{PHL} \text{ and } t_{PLH}.$ 

[2]  $\dot{t}_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

[3]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .

[4]  $t_t$  is the same as  $t_{THL}$  and  $t_{LLH}$ . [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).  $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:  $f_i$  = input frequency in MHz; f<sub>o</sub> = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

### Hex buffer/line driver; 3-state; inverting

#### Table 9. Dynamic characteristics 74HCT366-Q100

Voltages are referenced to GND (ground = 0 V);  $C_1$  = 50 pF unless otherwise specified; see test circuit Fig. 8.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C				1	1	
t <sub>pd</sub>	propagation delay	nA to nY; see <u>Fig. 6</u>	[1]				
		V <sub>CC</sub> = 4.5 V		-	13	24	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	11	-	ns
t <sub>en</sub>	enable time	OEn to nY; V <sub>CC</sub> = 4.5 V; see <u>Fig. 7</u>	[2]	-	16	35	ns
t <sub>dis</sub>	disable time	OEn to nY; V <sub>CC</sub> = 4.5 V; see <u>Fig. 7</u>	[3]	-	20	35	ns
t <sub>t</sub>	transition time	V <sub>CC</sub> = 4.5 V; see <u>Fig. 6</u>	[4]	-	5	12	ns
C <sub>PD</sub>	power dissipation capacitance	per buffer; $V_I$ = GND to ( $V_{CC}$ - 1.5 V)	[5]	-	30	-	pF
T <sub>amb</sub> = -4	40 °C to +85 °C						
t <sub>pd</sub>	propagation delay	nA to nY; $V_{CC}$ = 4.5 V; see <u>Fig. 6</u>	[1]	-	-	30	ns
t <sub>en</sub>	enable time	$\overline{\text{OEn}}$ to nY; V <sub>CC</sub> = 4.5 V; see <u>Fig. 7</u>	[2]	-	-	44	ns
t <sub>dis</sub>	disable time	OEn to nY; V <sub>CC</sub> = 4.5 V; see <u>Fig. 7</u>	[3]	-	-	44	ns
t <sub>t</sub>	transition time	V <sub>CC</sub> = 4.5 V; see <u>Fig. 6</u>	[4]	-	-	15	ns
T <sub>amb</sub> = -4	40 °C to +125 °C	·					
t <sub>pd</sub>	propagation delay	nA to nY; $V_{CC}$ = 4.5 V; see <u>Fig. 6</u>	[1]	-	-	36	ns
t <sub>en</sub>	enable time	OEn to nY; V <sub>CC</sub> = 4.5 V; see <u>Fig. 7</u>	[2]	-	-	53	ns
t <sub>dis</sub>	disable time	OEn to nY; V <sub>CC</sub> = 4.5 V; see <u>Fig. 7</u>	[3]	-	-	53	ns
t <sub>t</sub>	transition time	V <sub>CC</sub> = 4.5 V; see <u>Fig. 6</u>	[4]	-	-	18	ns

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

[2]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

[3]  $t_{\text{dis}}$  is the same as  $t_{\text{PHZ}}$  and  $t_{\text{PLZ}}.$ 

[3] t<sub>dis</sub> is the same as t<sub>PHZ</sub> and t<sub>PLZ</sub>.
[4] t<sub>t</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
[5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW). P<sub>D</sub> = C<sub>PD</sub> x V<sub>CC</sub><sup>2</sup> x f<sub>i</sub> x N + Σ(C<sub>L</sub> x V<sub>CC</sub><sup>2</sup> x f<sub>o</sub>) where: f<sub>i</sub> = input frequency in MHz;

 $f_o$  = output frequency in MHz;

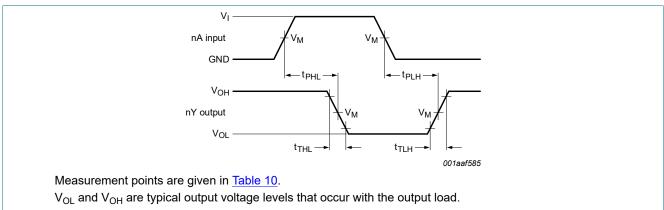
 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

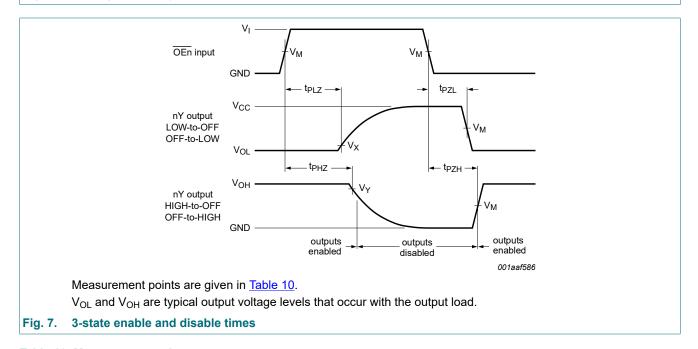
 $\Sigma(C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

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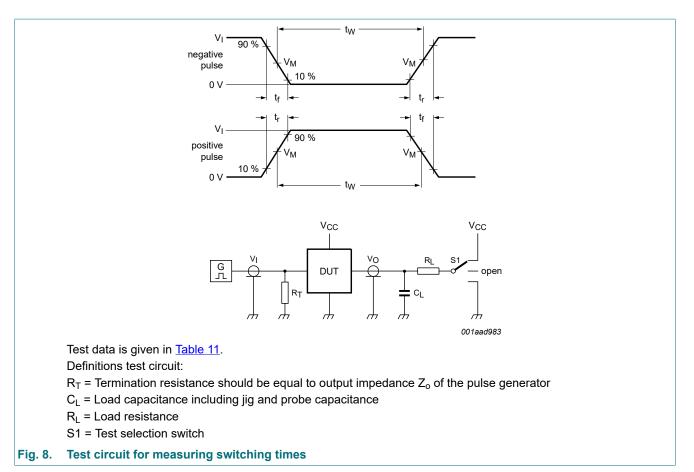
### 10.1. Waveforms and test circuit

Fig. 6. Propagation delay data input (nA) to output (nY) and output transition time



#### **Table 10. Measurement points** Input Output Туре VM VM ٧x VY 74HC366-Q100 0.1 x V<sub>CC</sub> 0.9 x V<sub>CC</sub> $0.5V_{CC}$ 0.5V<sub>CC</sub> 74HCT366-Q100 1.3 V 1.3 V 0.1 x V<sub>CC</sub> 0.9 x V<sub>CC</sub>

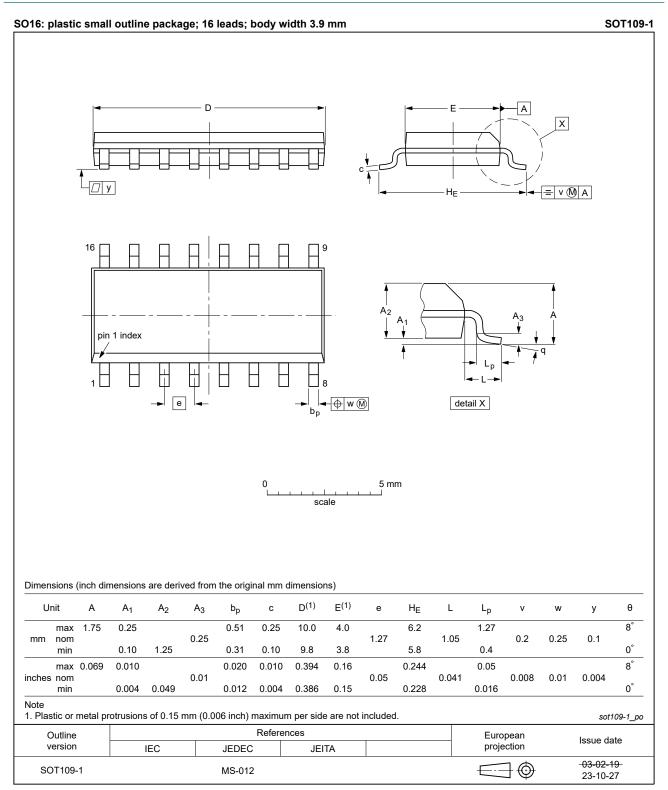
### Hex buffer/line driver; 3-state; inverting



#### Table 11. Test data

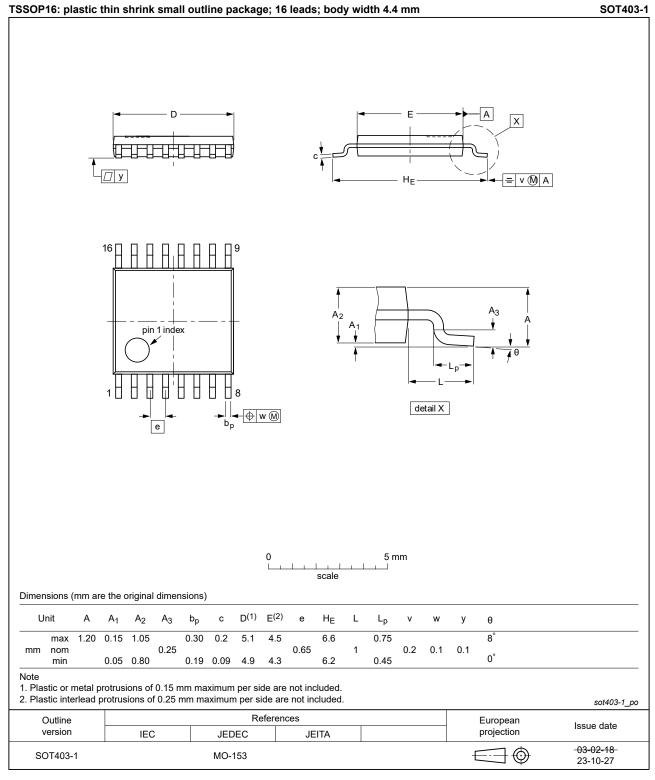
Туре	Input		Load		S1 position		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
74HC366-Q100	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>
74HCT366-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>

## **11. Package outline**



#### Fig. 9. Package outline SOT109-1 (SO16)

#### Hex buffer/line driver; 3-state; inverting





### 12. Abbreviations

#### Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model

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### Hex buffer/line driver; 3-state; inverting

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model

# 13. Revision history

Table 13. Revision history	1			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT366_Q100 v.3	20240313	Product data sheet	-	74HC_HCT366_Q100 v.2
Modifications:	<ul> <li><u>Section 2</u>: ESD specification updated according to the latest JEDEC standard.</li> <li><u>Fig. 9</u> and <u>Fig. 10</u>: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153.</li> </ul>			
74HC_HCT366_Q100 v.2	20210217	Product data sheet	-	74HC_HCT366_Q100 v.1
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li><u>Section 1</u> and <u>Section 2</u> updated.</li> <li><u>Section 7</u>: Derating values for P<sub>tot</sub> total power dissipation updated.</li> <li><u>Table 7</u>: Conditions for I<sub>OZ</sub> have changed for 74HCT366-Q100. (errata)</li> </ul>			
74HC_HCT366_Q100 v.1	20120807	Product data sheet	-	-

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### 14. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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#### Hex buffer/line driver; 3-state; inverting

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